

FGW75N60HC

Discrete IGBT

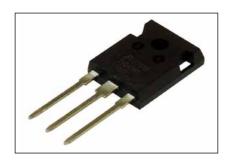
Discrete IGBT (High-Speed V series) 600V / 75A

■ Features

Low power loss Low switching surge and noise High reliability, high ruggedness (RBSOA, SCSOA etc.)

Applications

Uninterruptible power supply **PV Power Conditioner** Inverter welding machine

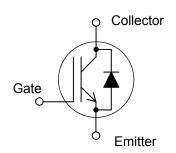


Equivalent circuit

■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings (at Tj=25°C unless otherwise specified)

| Items | Symbols | Characteristics | Units | Remarks |
|--------------------------------|---------------------|-----------------|-----------------------|---|
| Collector-Emitter Voltage | Vces | 600 | V | |
| Gate-Emitter Voltage | V _{GES} | ±20 | V | |
| DC Collector Current | Ic@25 | 100 | Α | Tc=25°C,Tj=150°C Note *1 |
| | Ic@100 | 75 | Α | Tc=100°C,Tj=150°C |
| Pulsed Collector Current | Icp | 225 | Α | Note *2 |
| Turn-Off Safe Operating Area | - | 225 | Α | V _{CE} ≤600V,T _J ≤175°C |
| Diode Forward Current | F@25 | 98 | Α | |
| | F@100 | 75 | Α | |
| Diode Pulsed Current | IFP | 225 | Α | Note *2 |
| Short Circuit Withstand Time | nd Time tsc 5 μs | 5 | 116 | Vcc≤300V,VgE=12V |
| Short Circuit Withstalia Time | | μδ | T _j ≤150°C | |
| IGBT Max. Power Dissipation | P _{D_IGBT} | 500 | W | Tc=25°C |
| FWD Max. Power Dissipation | P _{D_FWD} | 260 | VV | Tc=25°C |
| Operating Junction Temperature | Tj | -40 ~ +175 | ů | |
| Storage Temperature | T _{stg} | -55 ~ +175 | ç | |



Note *1 : Current value limited by bonding wire. Note *2 : Pulse width limited by Tjmax.

● Electrical characteristics (at T_i= 25°C unless otherwise specified)

| Description | Cumbala | Symbols Conditions | | Characteristics | | | Units | | |
|--------------------------------------|-----------------------|--|---|-----------------|--------------|------|-------|--|--|
| | Symbols | | | min. | typ. | max. | Units | | |
| Zero Gate Voltage Collector Current | Ices | $V_{CE} = 600V, V_{CE} = 0V$ $T_{j} = 175^{\circ}C$ $T_{j} = 175^{\circ}C$ | T _i =25°C | - | - | 250 | μΑ | | |
| Zero Gate voltage Collector Current | ICES | | T _i =175°C | - | - | 10 | mA | | |
| Gate-Emitter Leakage Current | Iges | $V_{CE} = 0V$, $V_{GE} = \pm 20V$ | | - | - | 200 | nA | | |
| Gate-Emitter Threshold Voltage | V _{GE (th)} | $V_{CE} = +20V$, $I_C = 75mA$ | | 4.0 | 5.0 | 6.0 | V | | |
| Collector-Emitter Saturation Voltage | V _{CE} (sat) | V _{GE} = +15V, I _C = 75A | T _i =25°C T _i =175°C | - | 1.50 1.80 | 1.95 | V | | |
| Input Capacitance | Cies | V _{CE} =25V | , | 3075 | 6150 | 9925 | pF | | |
| Output Capacitance | Coes | V _{GE} =0V | | 150 | 300 | 450 | | | |
| Reverse Transfer Capacitance | Cres | f=1MHz | | 120 | 240 | 360 | 1 " | | |
| Gate Charge | Q _G | V _{CC} = 400V I _C = 40A V _{GE} = 15V | | 230 | 460 | 690 | nC | | |
| Turn-On Delay Time | t _{d(on)} | T _j = 25°C | 23 | 47 | 71 | | | | |
| Rise Time | t | Vcc = 400V | 69 | 138 | 207 | | | | |
| Turn-Off Delay Time | t _{d(off)} | Ic = 75A | | 225 | 450 | 675 | ns | | |
| Fall Time | tr | V _{GE} = 15V 52 105 15 | | | 158 | | | | |
| Turn-On Energy | Eon | R _G = 10Ω | 1.9 | 3.8 | 5.7 | | | | |
| Turn-Off Energy | Eoff | L = 500μH Energy loss include "tail" ar recovery. | 2.1 | 4.2 | 6.3 | mJ | | | |
| Turn-On Delay Time | t _{d(on)} | T _i = 150°C | | 22 | 45 | 68 | | | |
| Rise Time | t | Vcc = 400V | | 69 | 138 | 207 | | | |
| Turn-Off Delay Time | t _{d(off)} | Ic = 75A | | 245 | 490 | 735 | ns ns | | |
| Fall Time | tr | V _{GE} = 15V | | 60 | 120 | 180 | | | |
| Turn-On Energy | Eon | $R_G = 10\Omega$ | | 2.7 | 5.3 | 2.8 | | | |
| Turn-Off Energy | Eoff | L = 500µH Energy loss include "tail" and FWD reverse recovery. | | | 4.8 | 7.2 | mJ | | |

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● FWD Characteristics

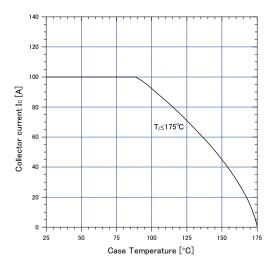
| Description | Symbol | Conditions | | Characteristics | | | Unit |
|-------------------------------|------------------|---|-----------------------|-----------------|------|------|------|
| Description | Syllibol | | | min. | typ. | max. | Onit |
| Famurand Valtage Duan | VF | I _F =75A | T _j =25°C | 1.3 | 2.25 | 2.95 | V |
| Forward Voltage Drop | | | T _i =175°C | 0.9 | 1.65 | 2.4 | V |
| Diode Reverse Recovery Time | t _{rr1} | Vcc=30V,I₅ = 7.5A -di/dt=200A/us | | 20 | 40 | 60 | ns |
| Diode Reverse Recovery Time | t _{rr2} | Vcc=400V I _F =75A | | 26 | 52 | 78 | ns |
| Diode Reverse Recovery Charge | Qrr | -di⊧/dt=200A/µs Tj=25°C | | 0.14 | 0.28 | 0.42 | μC |
| Diode Reverse Recovery Time | t _{rr2} | Vcc=400V I⊧=75A | | 105 | 210 | 315 | ns |
| Diode Reverse Recovery Charge | Qrr | -di _F /dt=200A/µs T _j =175°C | | 0.85 | 1.70 | 2.55 | μC |

● Thermal Resistance

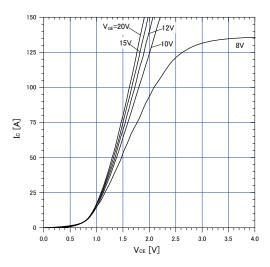
| Description | Symbols | Conditions | Characteristics | | | Units |
|---|---------------------------|------------|-----------------|------|-------|-------|
| Description | | Conditions | min. | typ. | max. | Units |
| Thermal Resistance, Junction-Ambient | R _{th(j-a)} | - | - | - | 50 | |
| Thermal Resistance, IGBT Junction to Case | R _{th(j-c)_IGBT} | - | - | - | 0.298 | °C/W |
| Thermal Resistance, FWD Junction to Case | R _{th(j-c)_FWD} | - | - | - | 0.568 | |

■ Characteristics (Representative)

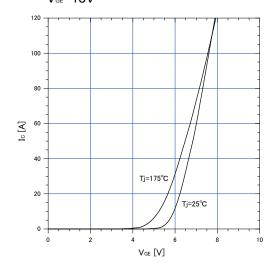
Graph.1 DC Collector Current vs T_c $V_{ce} \ge +15V$, $T_i \le 175$ °C



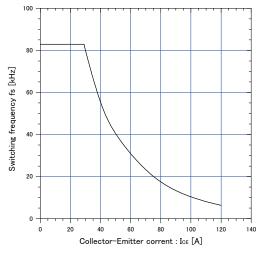
Graph.3
Typical Output Characteristics (VcE-lc)
T,=25°C



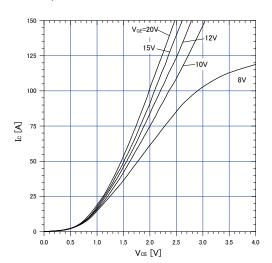
Graph.5 Typical Transfer Characteristics V_{GE} =15V



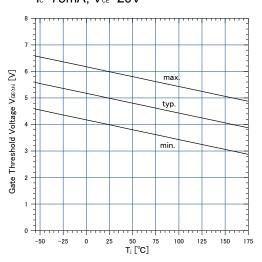
Graph.2 Collector Current vs. switching frequency V_{oe} =+15V, T_{o} ≤175°C, V_{co} =600V, D=0.5, R_{e} =10 Ω , T_{c} =100°C



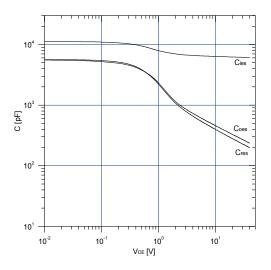
Graph.4
Typical Output Characteristics (V_{CE}-I_C)
T_.=175°C



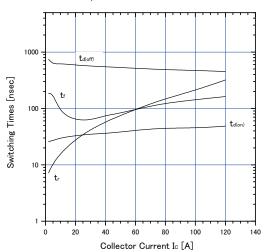
Graph.6
Gate Threshold Voltage vs. T_i
I_c=75mA, V_{cε}=20V



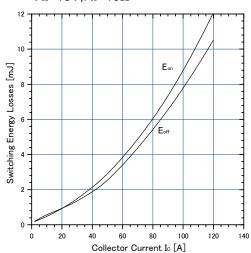
Graph.7 Typical Capacitance V_e=0V,f=1MHz,T,=25°C



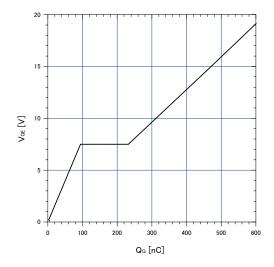
Graph.9 Typical switching time vs. I_c T_J=175°C,V_{cc}=600V,L=500 μ H V_{cE}=15V,R_c=10 Ω



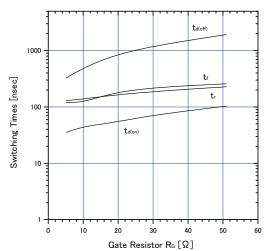
Graph.11 Typical switching losses vs. I_c T_j=175°C,V $_c$ =600V,L=500 μ H V $_c$ =15V,R $_c$ =10 Ω



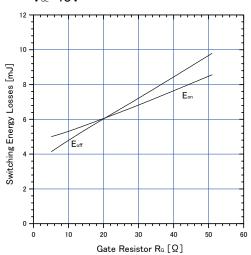
Graph.8 Typical Gate Charge V∞=6000V,I₀=75A,T,=25°C



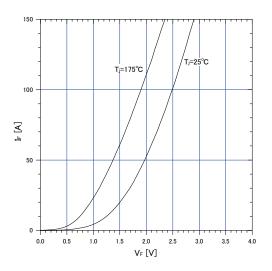
Graph.10 Typical switching time vs. $R_{\text{\tiny G}}$ T_J=175°C,V_{cc}=600V,I_c=75A,L=500 μ H V_{GE}=15V



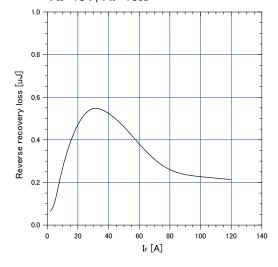
Graph.12
Typical switching losses vs. R_s
T_i=175°C,V_{cs}=600V,I_c=75A,L=500μH
V_{sε}=15V



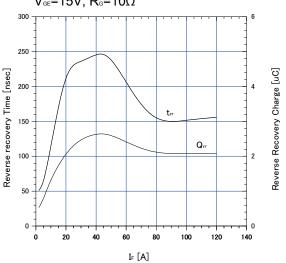
Graph.13 FWD Forward voltage drop (V_F-I_F)



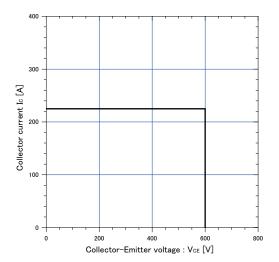
Graph.15 Typical reverse recovery loss vs. I_F $T_r=175^{\circ}C$, $V_{cc}=600V$, $L=500\mu H$ $V_{ce}=15V$, $R_c=10\Omega$



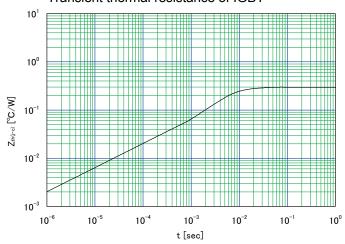
Graph.14 Typical reverse recovery characteristics vs. I_{F} T_{J} =175°C, V_{cc} =600V, L=500 μH V_{ce} =15V, R_{c} =10 Ω



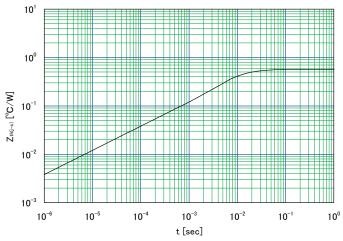
Graph.16
Reverse biased Safe Operating Area $T_i \le 175^{\circ}C$, $V_{ce} = +15V/0V$, $R_c = 10\Omega$



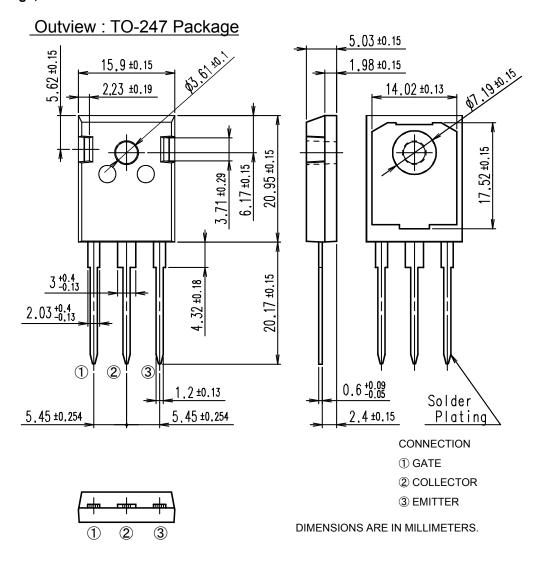
Graph.17 Transient thermal resistance of IGBT



Graph.18
Transient thermal resistance of FWD



■ Outline Drawings, mm



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